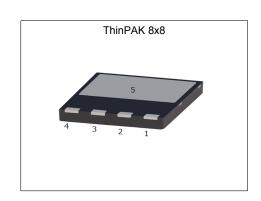


MOSFET

650V CoolMOS™ CFD7 SJ Power Device

The latest 650 V CoolMOS™ CFD7 extends the voltage class offering of the CFD7 family and is a successor to the 650 V CoolMOS™ CFD2. Resulting from improved switching performance and excellent thermal behavior, 650 V CooMOS™ CFD7 offers highest efficiency in resonant switching topologies, such as LLC and phase-shift-full-bridge (ZVS). As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness. The CoolMOS™ CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions.



Features

- · Ultra-fast body diode
- 650V break down voltage
- Best-in-class R_{DS(on)}
- · Reduced switching losses
- Low R_{DS(on)} dependency over temperature

Benefits

- Excellent hard commutation ruggedness
- · Extra safety margin for designs with increased bus voltage
- Enabling increased power density solutions
- Outstanding light load efficiency in industrial SMPS applications
- Improved full load efficiency in industrial SMPS applications
- Price competitiveness over previous CoolMOS™ families

Potential applications

Suitable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging, Solar



Fully qualified according to JEDEC for Industrial Applications

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.



Parameter	Value	Unit
V _{DS} @ T _{j,max}	700	V
R _{DS(on),max}	65	mΩ
$Q_{g,typ}$	68	nC
I _{D,pulse}	139	A
E _{oss} @ 400V	9.5	μJ
Body diode di _F /dt	1300	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPL65R065CFD7	PG-VSON-4	65R065F7	see Appendix A

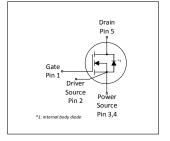












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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Demonstra	Ol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	33 23	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	139	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	171	mJ	I _D =5.1A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.86	mJ	I _D =5.1A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	5.1	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	195	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-40	-	150	°C	-	
Operating junction temperature	T _j	-40	-	150	°C	-	
Mounting torque	-	-	-	-	Ncm	-	
Continuous diode forward current ¹⁾	I _S	-	-	33	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	139	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V_{DS} =0400V, I_{SD} <=16.4A, T_{j} =25°C see table 8	
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs	V_{DS} =0400V, I_{SD} <=16.4A, T_{j} =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch with identical R_G

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2 Thermal characteristics

Table 3 Thermal characteristics

Paramatan.	Ol	Values		11:4	Nata / Tank Oam dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.64	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	$R_{ m thJA}$	-	35	45	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling.
Soldering temperature, wave- & reflow soldering allowed	T _{sold}	-	-	260	°C	reflow MSL2A

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Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Consolo a l		Values				
Parameter	Symbol	Min.			Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_{D} =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.86{\rm mA}$	
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 13	1 37	μΑ	V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =125°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.053 0.116	0.065	Ω	V _{GS} =10V, I _D =16.4A, T _j =25°C V _{GS} =10V, I _D =16.4A, T _j =150°C	
Gate resistance	R _G	-	5.8	-	Ω	f=1MHz, open drain	

Table 5 **Dynamic characteristics**

Parameter	Or made at		Value	s	11		
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Input capacitance	Ciss	-	3288	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	51	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ²⁾	$C_{ m o(er)}$	- 119 - pF		pF	V _{GS} =0V, V _{DS} =0400V		
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	1231	-	pF	I _D =constant, V _{GS} =0V, V _{DS} =0400V	
Turn-on delay time	t _{d(on)}	-	27	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Rise time	t _r	-	8	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	121	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	C. mah al		Value	s	1111111	Note / Took Condition	
	Symbol	Min.			Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	19	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =16.4A, $V_{\rm GS}$ =0 to 10V	
Gate to drain charge	$Q_{ m gd}$	-	21	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =16.4A, $V_{\rm GS}$ =0 to 10V	
Gate charge total	Qg	-	68	-	nC	V _{DD} =400V, I _D =16.4A, V _{GS} =0 to 10V	
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	V _{DD} =400V, I _D =16.4A, V _{GS} =0 to 10V	

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

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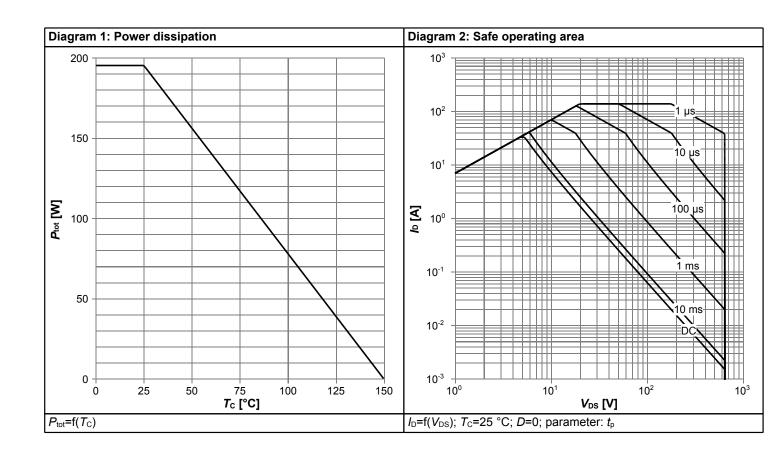


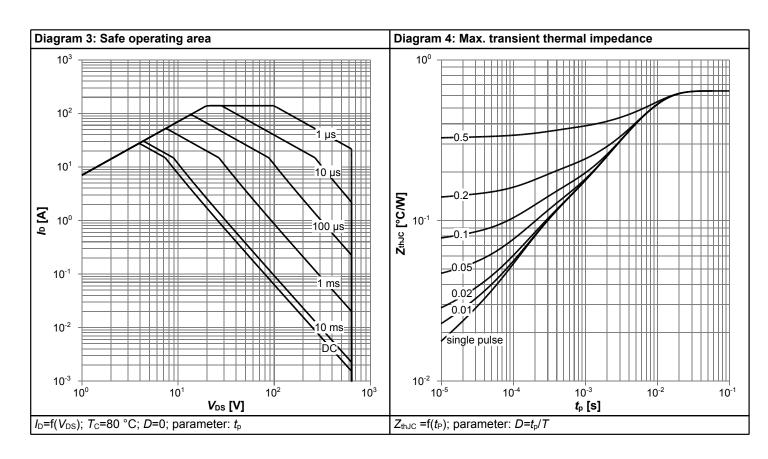
Table 7 Reverse diode characteristics

Donomotor	Symbol	Values			11:4	Note / Took Condition	
Parameter	Symbol	Symbol Min. Typ. M		Max.	Unit	Note / Test Condition	
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =16.4A, T _j =25°C	
Reverse recovery time	t _{rr}	-	156	234	ns	V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8	
Reverse recovery charge	Qrr	-	0.86	1.72	μC	V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	10.1	-	Α	V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8	



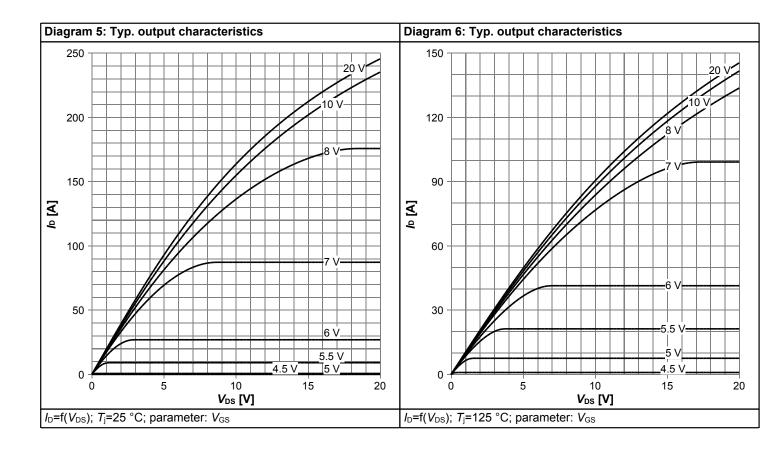
4 Electrical characteristics diagrams

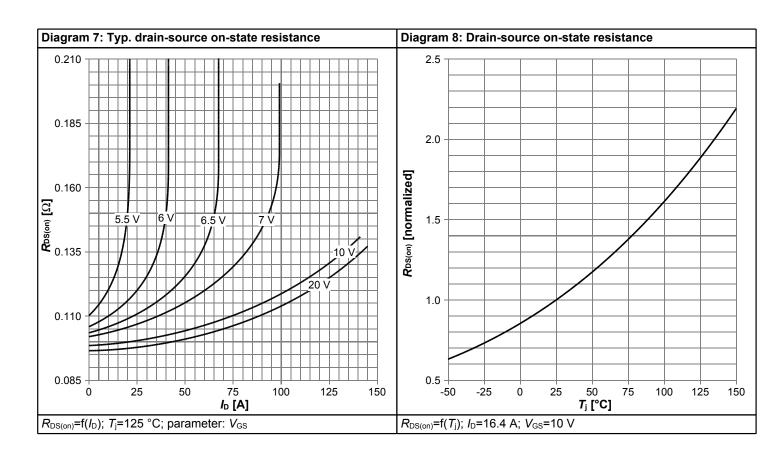




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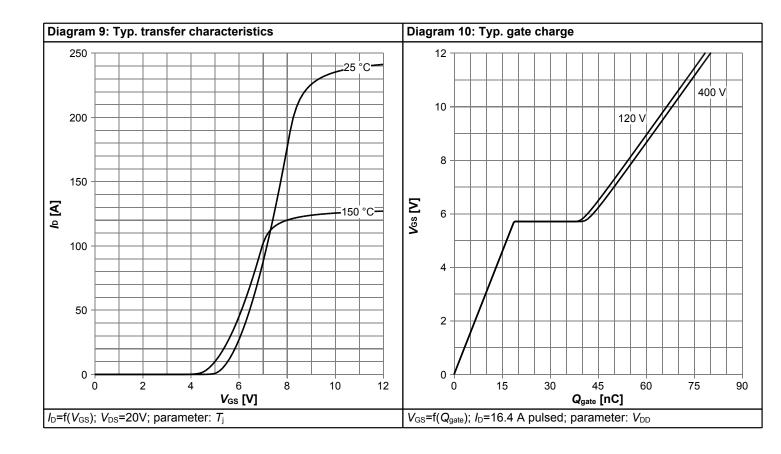


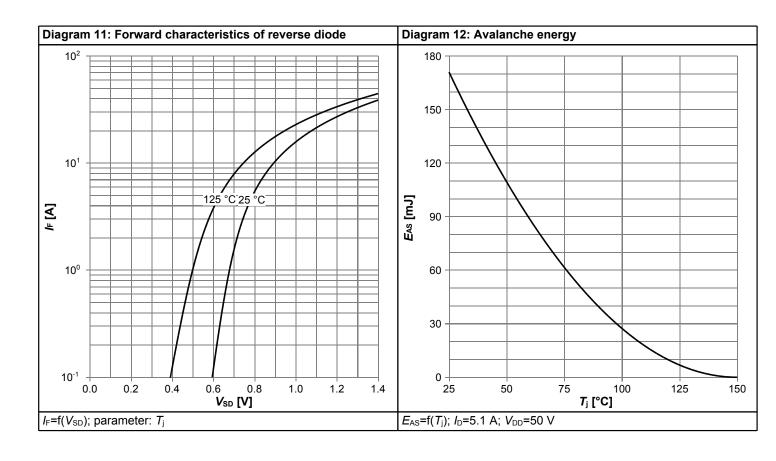




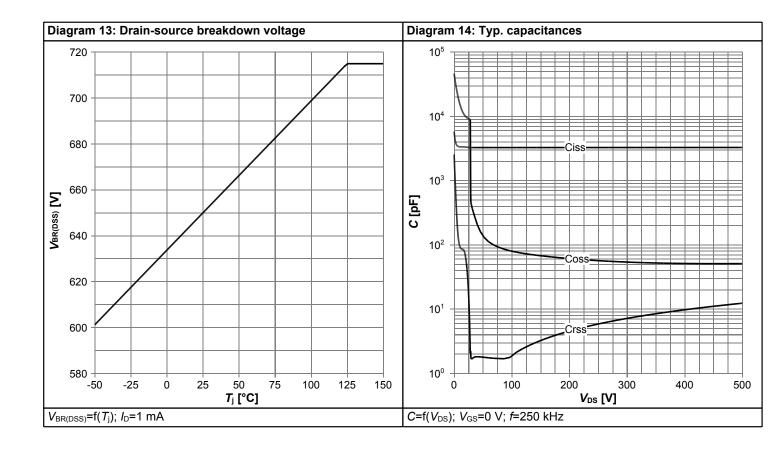
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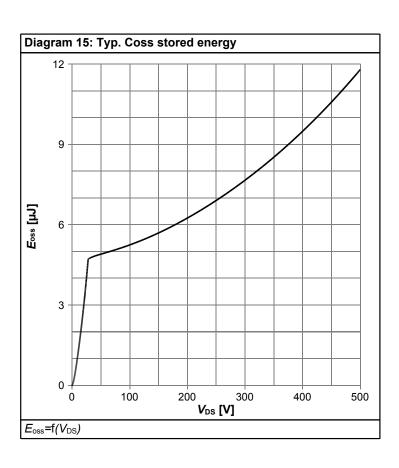














5 Test Circuits

Table 8 Diode characteristics

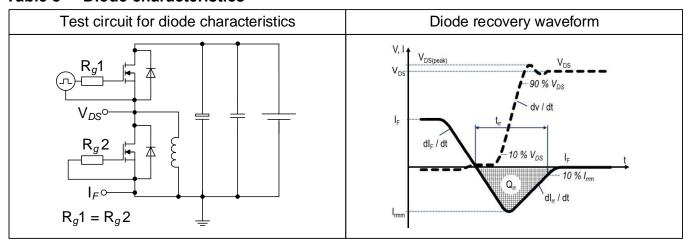


Table 9 Switching times (ss)

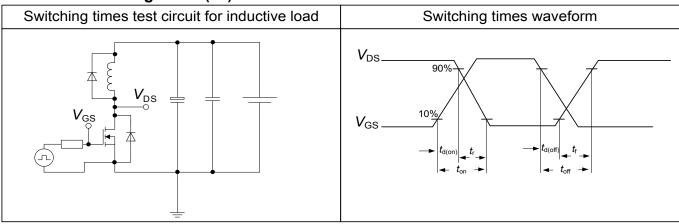
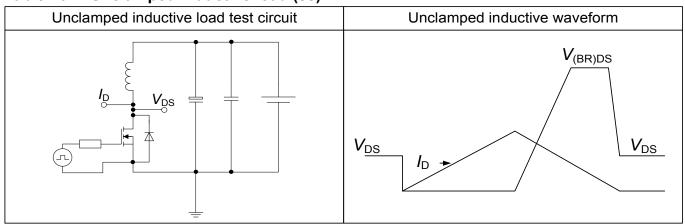
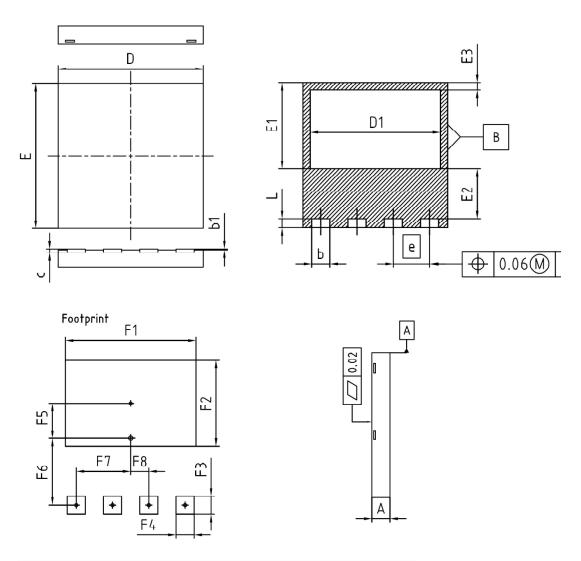


Table 10 Unclamped inductive load (ss)





6 Package Outlines



DIM	MILLIME	ETERS	INCH	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.90	1.10	0.035	0.043	
b	0.90	1.10	0.035	0.043	
ь1	0.00	0.05	0.000	0.002	
С	0.10	0.30	0.004	0.012	
D	7.90	8.10	0.311	0.319	
D1	7.10	7.30	0.280	0.287	
E	7.90	8.10	0.311	0.319	
E1	4.65	4.85	0.183	0.191	
E2	2.65	2.85	0.104	0.112	
E3	0.30	0.50	0.012	0.020	
е	2,	00 (BSC)	0.079 (BSC)		
L	0.40	0.60	0.016	0.024	
N	4	4		4	
F1	7.2	0	0.283		
F2	4.7	'5	0.187		
F3	1.0	0	0.0)39	
F4	1.0	0	0.039		
F5	1.4	3	0.056		
F6	4.2	10	0.165		
F7	3.0	0	0.118		
F8	1.0	0	0.0)39	

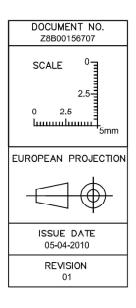


Figure 1 Outline PG-VSON-4, dimensions in mm/inches

650V CoolMOS™ CFD7 SJ Power Device IPL65R065CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 650V Webpage: www.infineon.com

• IFX CoolMOS CFD7 650V application note: www.infineon.com

• IFX CoolMOS CFD7 650V simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPL65R065CFD7



Revision History

IPL65R065CFD7

Revision: 2021-07-28, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2021-07-28	Release of final version			

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Final Data Sheet 14 Rev. 2.0, 2021-07-28